

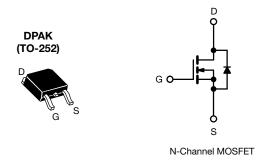
Vishay Siliconix

HALOGEN

FREE

D Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 1.5			
Q _g max. (nC)	20			
Q _{gs} (nC)	3			
Q _{gd} (nC)	5			
Configuration	Single			



FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qg
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION		
Package	DPAK (TO-252)	
Lead (Pb)-free	SiHD5N50D-E3	
	SiHD5N50D-GE3	
Lead (Pb)-free and Halogen-free	SiHD5N50DT1-GE3	
Leau (FD)-lifee aliu Halogeli-lifee	SiHD5N50DT4-GE3	
	SiHD5N50DT5-GE3	

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	500	
Gate-Source Voltage				± 30	V
Gate-Source Voltage AC (f > 1 Hz)			V_{GS}	30	
Continuous Drain Current /T 150 °C\	\/ at 10 \/	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	_	5.3	
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_C = 100 ^{\circ}C$	I _D	3.4	Α	
Pulsed Drain Current ^a		I _{DM}	10		
Linear Derating Factor			0.83	W/°C	
Single Pulse Avalanche Energy b		E _{AS}	28.8	mJ	
Maximum Power Dissipation		P _D	104	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		24	1//20	
Reverse Diode dV/dt ^d		dV/dt	0.28	- V/ns	
Soldering Recommendations (Peak temperature) c for 10 s			300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.2	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				L	L		1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zoro Coto Valtoro Duoin Current	1	V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	μА
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 400 \text{ V}$	V, V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.5 A	-	1.2	1.5	Ω
Forward Transconductance a	9 _{fs}	V _{DS} :	= 20 V, I _D = 2.5 A	-	1.8	-	S
Dynamic							
Input Capacitance	C_{iss}		$V_{GS} = 0 V$	-	325	-	
Output Capacitance	C_{oss}]	$V_{DS} = 100 \text{ V},$	-	34	-	
Reverse Transfer Capacitance	C _{rss}	1	f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	V 0V 400 V V 0V		-	31	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		41	-	
Total Gate Charge	Q_g		V _{GS} = 10 V		10	20	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			3	-	nC
Gate-Drain Charge	Q _{gd}	1		-	5	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 400 V, I _D = 2.5 A		-	12	24	
Rise Time	t _r			-	11	22	
Turn-Off Delay Time	t _{d(off)}		$R_g = 9.1 \Omega$, $V_{GS} = 10 V$		14	28	ns
Fall Time	t _f			-	11	22	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.7	-	Ω
Drain-Source Body Diode Characteristic	s						•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	5	^
Pulsed Diode Forward Current	I _{SM}			-	-	20	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 4 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}$, $I_F = I_S = 2.5 \text{A}$, $dI/dt = 100 \text{A/}\mu\text{s}$, $V_R = 20 \text{V}$		-	320	-	ns
Reverse Recovery Charge	Q _{rr}			-	1.2	-	μC
Reverse Recovery Current	I _{RRM}			-	8	_	Α

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

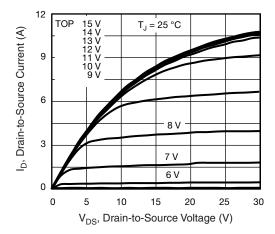


Fig. 1 - Typical Output Characteristics

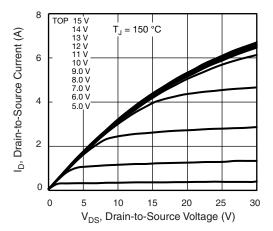


Fig. 2 - Typical Output Characteristics

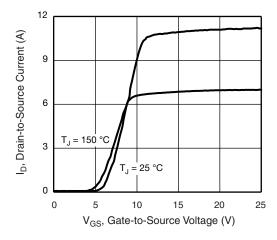


Fig. 3 - Typical Transfer Characteristics

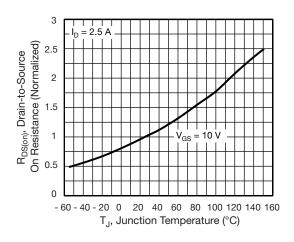


Fig. 4 - Normalized On-Resistance vs. Temperature

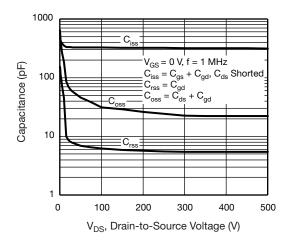


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

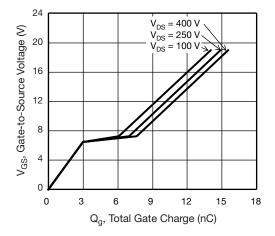


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

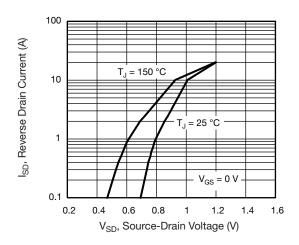


Fig. 7 - Typical Source-Drain Diode Forward Voltage

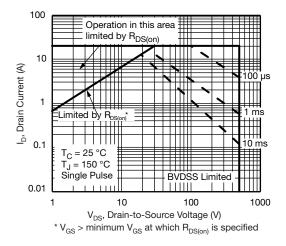


Fig. 8 - Maximum Safe Operating Area

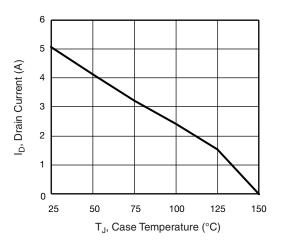


Fig. 9 - Maximum Drain Current vs. Case Temperature

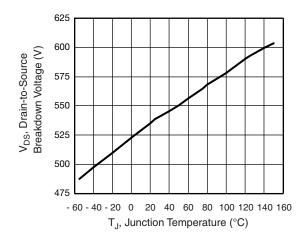


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

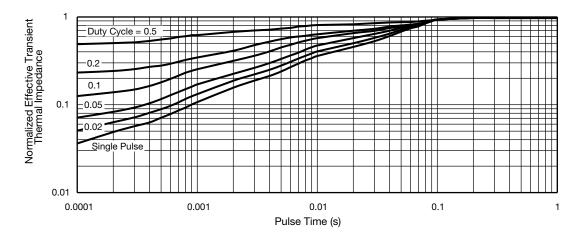


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



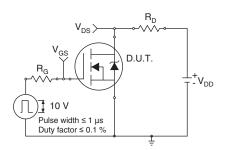


Fig. 12 - Switching Time Test Circuit

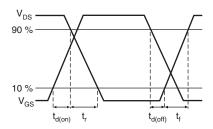


Fig. 13 - Switching Time Waveforms

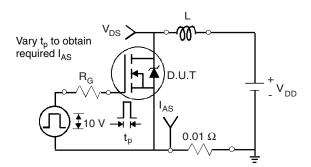


Fig. 14 - Unclamped Inductive Test Circuit

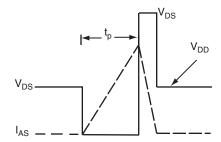


Fig. 15 - Unclamped Inductive Waveforms

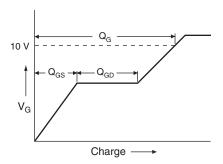


Fig. 16 - Basic Gate Charge Waveform

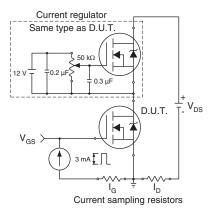
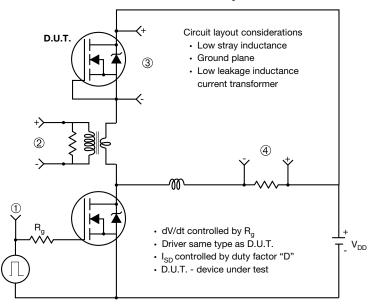


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



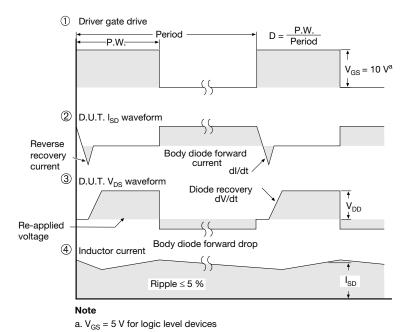


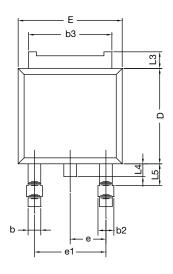
Fig. 18 - For N-Channel

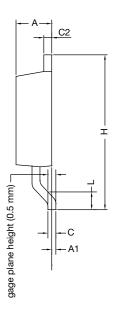
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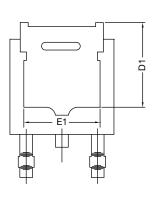


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







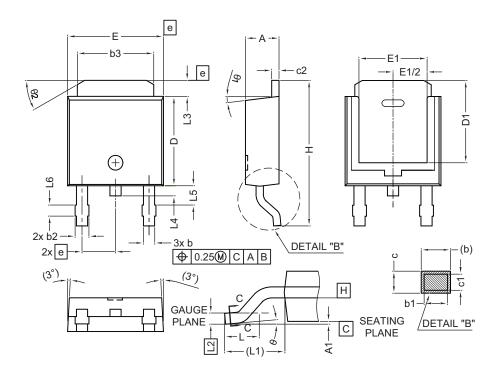
	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	=	
E	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ł ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

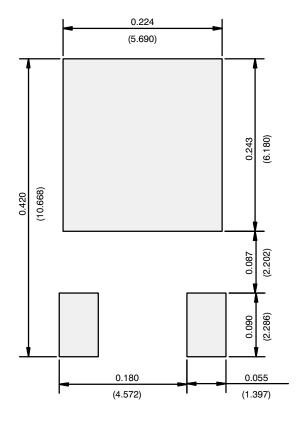
- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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